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Electronic Version

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Title of Invention	METHOD OF SOLDERING SEMICONDUCTOR PART AND MOUNTED STRUCTURE OF SEMICONDUCTOR PART				
Application Number : Date : First Named Applicant: Akihiro Mano Confirmation Number: Attorney Docket Number: 22040-00034-US1					
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<table border="1"><tr><td>Submitted By:</td><td>Elec. Sign.</td></tr><tr><td>Larry J. Hume Registered Number: 44,163</td><td>/ljh/</td></tr></table>		Submitted By:	Elec. Sign.	Larry J. Hume Registered Number: 44,163	/ljh/
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Larry J. Hume Registered Number: 44,163	/ljh/				

Documents being submitted:	Files
application-body	2204000034US1-usappb.xml application-body.dtd us-application-body.xsl mathml2.dtd soextblx.dtd isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isogr1.ent isogr2.ent isogr3.ent isogr4.ent isolat1.ent isolat2.ent isomfrk.ent isomopf.ent isomscr.ent isonum.ent isopub.ent isotech.ent mathml2-qname-1.mod mmlalias.ent mmlextra.ent wipo.ent 2204000034US1-usappb-D000001.tif 2204000034US1-usappb-D000002.tif 2204000034US1-uspoat-O000001.tif 2204000034US1-uspoat-O000002.tif 2204000034US1-uspoat-O000003.tif 2204000034US1-uspoat-O000004.tif 2204000034US1-uspoat-O000005.tif 2204000034US1-usrequ.xml us-request.dtd us-request.xsl 2204000034US1-usdecl-O000001.tif 2204000034US1-usdecl-O000002.tif 2204000034US1-usdecl-O000003.tif 2204000034US1-usdecl-O000004.tif 2204000034US1-usassn.xml us-assignment.dtd us-assignment.xsl 2204000034US1-usassn-A000001.tif
us-power-of-attorney-grant	
us-power-of-attorney-grant	
us-power-of-attorney-grant	
us-power-of-attorney-grant	
us-power-of-attorney-grant	
us-request	
us-declaration	
us-declaration	
us-declaration	
us-declaration	
us-assignment	

us-fee-sheet	2204000034US1-usassn-A000002.tif
	2204000034US1-usassn-A000003.tif
	2204000034US1-usassn-A000004.tif
	2204000034US1-usfees.xml
	us-fee-sheet.dtd
	us-fee-sheet.xsl
Comments	
IPDAS Version 3.4.4.0, Validation Version 1.1.1.2, Submission Version 1.2.0.0	